

# PBL 386 21/2 Subscriber Line Interface Circuit

## Description

The PBL 386 21/2 Subscriber Line Interface Circuit (SLIC) is a 90 V bipolar integrated circuit for use in DAML, FITL and other telecommunications equipment. The PBL 386 21/2 has been optimized for low total line interface cost and a high degree of flexibility in different applications.

The PBL 386 21/2 has constant current feed, programmable to max. 30 mA.

A second lower battery voltage may be connected to the device to reduce short loop power dissipation. The SLIC automatically switches between the two battery supply voltages without need for external components or external control.

The SLIC incorporates loop current, ground key and ring trip detection functions. The PBL 386 21/2 is compatible with loop start signaling.

Two- to four-wire and four- to two-wire voice frequency (VF) signal conversion is accomplished by the SLIC in conjunction with either a conventional CODEC/filter or with a programmable CODEC/filter, e.g. SLAC, SiCoFi, Combo II. The programmable two-wire impedance, complex or real, is set by a simple external network.

Longitudinal voltages are suppressed by a feedback loop in the SLIC and the longitudinal balance specifications meet Bellcore TR909 requirements.

The PBL 386 21/2 package options are 24-pin SSOP, 24-pin SOIC or 28-pin PLCC.

## Key Features

- 24-pin SSOP package
- High and low battery with automatic switching
- 60 mW on-hook power dissipation in active state
- On-hook transmission
- Long loop battery feed tracks Vbat for maximum line voltage
- Only +5 V feed in addition to battery
- Selectable transmit gain (1x or 0.5x)
- No power-up sequence
- 44V open loop voltage @ -48V battery feed
- Full longitudinal current capability during on-hook state
- Analog over temperature protection permits transmission while the protection circuit is active
- Polarity reversal
- Integrated Ring Relay driver
- Ground key detector
- Programmable signal headroom
- -40 °C to +85 °C ambient temperature range

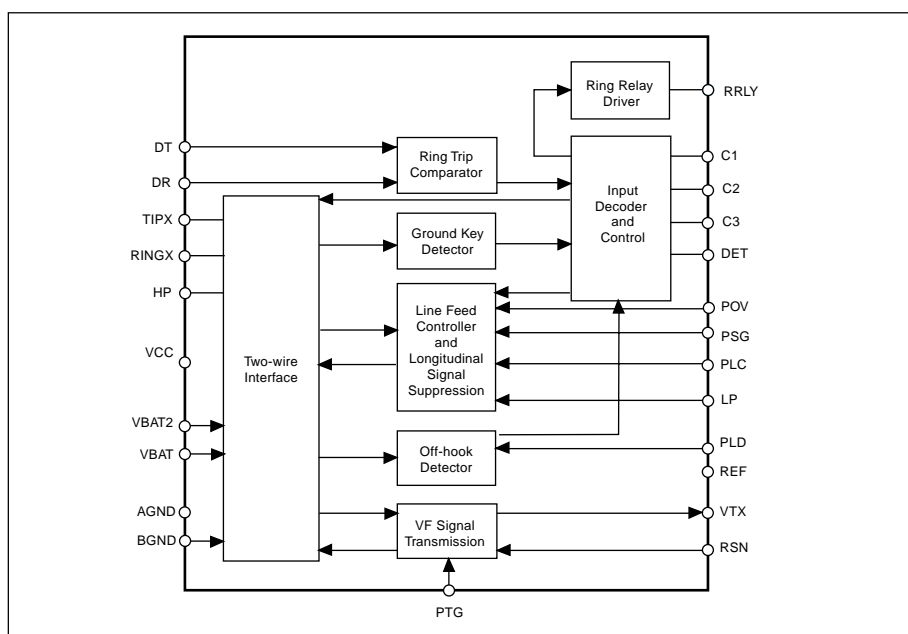
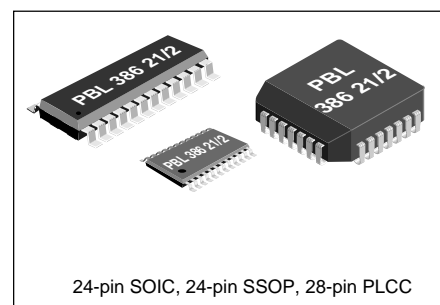


Figure 1. Block diagram.



## Maximum Ratings

Parameter	Symbol	Min	Max	Unit
<b>Temperature, Humidity</b>				
Storage temperature range	$T_{Stg}$	-55	+150	°C
Operating temperature range	$T_{Amb}$	-40	+110	°C
Operating junction temperature range, Note 1	$T_J$	-40	+140	°C
<b>Power supply, <math>-40\text{ °C} \leq T_{Amb} \leq +85\text{ °C}</math></b>				
$V_{CC}$ with respect to A/BGND	$V_{CC}$	-0.4	6.5	V
$V_{Bat2}$ with respect to A/BGND	$V_{Bat2}$	$V_{Bat}$	0.4	V
$V_{Bat}$ with respect to A/BGND, continuous	$V_{Bat}$	-75	0.4	V
$V_{Bat}$ with respect to A/BGND, 10 ms	$V_{Bat}$	-80	0.4	V
<b>Power dissipation</b>				
Continuous power dissipation at $T_{Amb} \leq +85\text{ °C}$	$P_D$		1.5	W
<b>Ground</b>				
Voltage between AGND and BGND	$V_G$	-0,3	0,3	V
<b>Relay Driver</b>				
Ring relay supply voltage			BGND+14	V
<b>Ring trip comparator</b>				
Input voltage	$V_{DT}, V_{DR}$	$V_{Bat}$	AGND	V
Input current	$I_{DT}, I_{DR}$	-5	5	mA
<b>Digital inputs, outputs (C1, C2, C3, DET)</b>				
Input voltage	$V_{ID}$	-0.4	$V_{CC}$	V
Output voltage	$V_{OD}$	-0.4	$V_{CC}$	V
<b>TIPX and RINGX terminals, <math>-40\text{ °C} &lt; T_{Amb} &lt; +85\text{ °C}</math>, <math>V_{Bat} = -50V</math></b>				
Maximum supplied TIPX or RINGX current	$I_{TIPX}, I_{RINGX}$	-100	+100	mA
TIPX or RINGX voltage, continuous (referenced to AGND), Note 2	$V_{TA}, V_{RA}$	-80	2	V
TIPX or RINGX, pulse $< 10\text{ ms}$ , $t_{Rep} > 10\text{ s}$ , Note 2	$V_{TA}, V_{RA}$	$V_{Bat} -10$	5	V
TIPX or RINGX, pulse $< 1\text{ }\mu\text{s}$ , $t_{Rep} > 10\text{ s}$ , Note 2	$V_{TA}, V_{RA}$	$V_{Bat} -25$	10	V
TIPX or RINGX, pulse $< 250\text{ ns}$ , $t_{Rep} > 10\text{ s}$ , Notes 2 & 3	$V_{TA}, V_{RA}$	$V_{Bat} -35$	15	V

## Recommended Operating Condition

Parameter	Symbol	Min	Max	Unit
Ambient temperature	$T_{Amb}$	-40	+85	°C
$V_{CC}$ with respect to AGND	$V_{CC}$	4.75	5.25	V
$V_{Bat}$ with respect to AGND	$V_{Bat}$	-58	-8	V
AGND with respect to BGND	$V_G$	-100	100	mV

## Notes

1. The circuit includes thermal protection. Operation at or above 140°C junction temperature may degrade device reliability.
2. With the diodes  $D_{VB}$  and  $D_{VB2}$  included, see figure 12.
3.  $R_{F1}$  and  $R_{F2} \geq 20\text{ }\Omega$  is also required. Pulse is applied to TIP and RING outside  $R_{F1}$  and  $R_{F2}$ .

**Electrical Characteristics**

-40 °C ≤ T<sub>Amb</sub> ≤ +85 °C, PTG = open (see pin description), V<sub>CC</sub> = +5V ±5 %, V<sub>Bat</sub> = -58V to -40V, V<sub>Bat2</sub> = -17V, R<sub>LC</sub>=38.3 kΩ, I<sub>L</sub> = 22 mA. R<sub>L</sub> = 600 Ω, R<sub>F1</sub> = R<sub>F2</sub> = R<sub>P1</sub> = R<sub>P2</sub>=0, R<sub>Ref</sub> = 49.9 kΩ, C<sub>HP</sub> = 47 nF, C<sub>LP</sub>=0.15 μF, R<sub>T</sub> = 120 kΩ, R<sub>SG</sub> = 0 kΩ, R<sub>RX</sub> = 60 kΩ, R<sub>R</sub> = 52.3 kΩ R<sub>OV</sub> = ∞ unless otherwise specified. Current definition: current is positive if flowing into a pin.

Parameter	Ref fig	Conditions	Min	Typ	Max	Unit
<b>Two-wire port</b>						
Overload level, V <sub>TRO</sub>	2	Active state 1% THD	1.0			V <sub>Peak</sub>
On-Hook, I <sub>Ldc</sub> ≤ 5mA		Note 1, R <sub>OV</sub> = ∞	1.0			V <sub>Peak</sub>
Input impedance, Z <sub>TR</sub>		Note 2		Z <sub>T</sub> /200		
Longitudinal impedance, Z <sub>LOT</sub> , Z <sub>LOR</sub>		0 < f < 100 Hz		20	35	Ω/wire
Longitudinal current limit, I <sub>LOT</sub> , I <sub>LOR</sub>		active state	10			mA <sub>rms</sub> /wire
Longitudinal to metallic balance, B <sub>LM</sub>		IEEE standard 455-1985, Z <sub>TRX</sub> =736Ω				
		0.2 kHz < f < 1.0 kHz	53			dB
		1.0 kHz < f < 3.4 kHz	53			dB
		Reverse polarity 0.2 kHz < f < 3.4 kHz	53			dB
Longitudinal to metallic balance, B <sub>LME</sub>	3	0.2 kHz < f < 1.0 kHz	53	75		dB
		1.0 kHz < f < 3.4 kHz	53	70		dB
		Reverse polarity 0.2 kHz < f < 3.4 kHz	53	68		dB
		B <sub>LME</sub> = 20 • Log   $\frac{E_{Lo}}{V_{TR}}$				
Longitudinal to four-wire balance, B <sub>LFE</sub>	3	0.2 kHz < f < 1.0 kHz	53	75		dB
		1.0 kHz < f < 3.4 kHz	53	70		dB
		Reverse polarity 0.2 kHz < f < 3.4 kHz	53	68		dB
		B <sub>LFE</sub> = 20 • Log   $\frac{E_{Lo}}{V_{TX}}$				
Metallic to longitudinal balance, B <sub>MLE</sub>	4	0.2 kHz < f < 3.4 kHz	40	50		dB
		B <sub>MLE</sub> = 20 • Log   $\frac{V_{TR}}{V_{Lo}}$  ; E <sub>RX</sub> = 0				

Figure 2. Overload level, V<sub>TRO</sub>, two-wire port

$$\frac{1}{\omega C} \ll R_L, R_L = 600 \Omega$$

$$R_T = 120 \text{ k}\Omega, R_{RX} = 60 \text{ k}\Omega$$

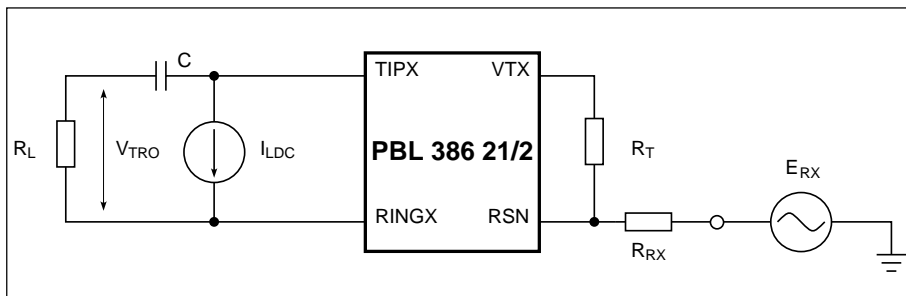
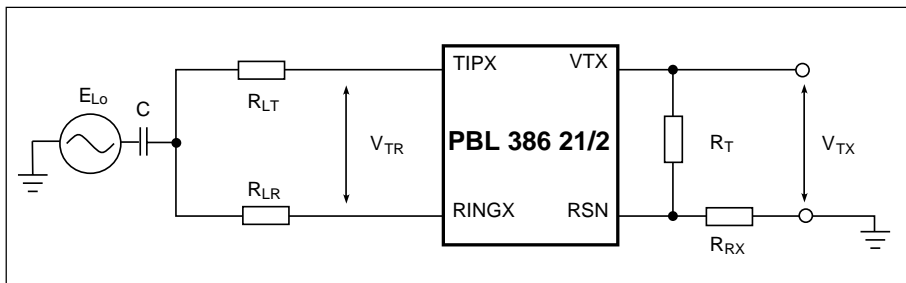


Figure 3. Longitudinal to metallic (B<sub>LME</sub>) and Longitudinal to four-wire (B<sub>LFE</sub>) balance

$$\frac{1}{\omega C} \ll 150 \Omega, R_{LR} = R_{LT} = R_L / 2 = 300 \Omega$$

$$R_T = 120 \text{ k}\Omega, R_{RX} = 60 \text{ k}\Omega$$



Parameter	Ref fig	Conditions	Min	Typ	Max	Unit
Four-wire to longitudinal balance, $B_{FLE}$	4	$0.2 \text{ kHz} < f < 4.0 \text{ kHz}$ $B_{FLE} = 20 \cdot \text{Log} \left  \frac{E_{RX}}{V_{Lo}} \right $	40	50		dB
Two-wire return loss, $r$		$r = 20 \cdot \text{Log} \frac{ Z_{TR} + Z_L }{ Z_{TR} - Z_L }$ $0.2 \text{ kHz} < f < 1.0 \text{ kHz}$ $1.0 \text{ kHz} < f < 3.4 \text{ kHz, Note 3}$	27	35		dB
TIPX idle voltage, $V_{Ti}$		active, $I_L = 0 \text{ mA}$		- 1.1		V
RINGX idle voltage, $V_{Ri}$		active, $I_L = 0 \text{ mA}$		$V_{Bat} + 2.5$		V
$V_{TR}$		active, $I_L = 0 \text{ mA}$		$V_{Bat} + 3.6$		V
<b>Four-wire transmit port (VTX)</b>						
Overload level, $V_{TXO}$	5	Load impedance $> 20 \text{ k}\Omega$ , 1% THD, Note 4	1.0			$V_{Peak}$
On-hook, $I_L \leq 5 \text{ mA}$			1.0			$V_{Peak}$
Output offset voltage $\Delta V_{TX}$			-100	0	100	mV
Output impedance, $Z_{TX}$		$0.2 \text{ kHz} < f < 3.4 \text{ kHz}$		15	50	$\Omega$
<b>Four-wire receive port (RSN)</b>						
Receive summing node (RSN) DC voltage		$I_{RSN} = -55 \mu\text{A}$	1.15	1.25	1.35	V
Receive summing node (RSN) impedance		$0.2 \text{ kHz} < f < 3.4 \text{ kHz}$		8	20	$\Omega$
Receive summing node (RSN) current ( $I_{RSN}$ ) to metallic loop current ( $I_L$ ) gain, $\alpha_{RSN}$		$0.3 \text{ kHz} < f < 3.4 \text{ kHz}$		200		ratio
<b>Frequency response</b>						
Two-wire to four-wire, $g_{2-4}$	6	relative to 0 dBm, 1.0 kHz. $E_{RX} = 0 \text{ V}$ $0.3 \text{ kHz} < f < 3.4 \text{ kHz}$ $f = 8.0 \text{ kHz, 12 kHz, 16 kHz}$	-0.20		0.10	dB
			-1.0		0.1	dB

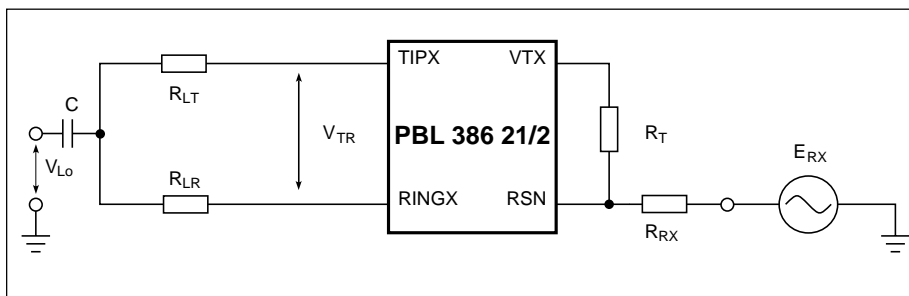


Figure 4. Metallic to longitudinal and four-wire to longitudinal balance

$$\frac{1}{\omega C} \ll 150 \Omega, R_{LT} = R_{LR} = R_L / 2 = 300 \Omega$$

$$R_T = 120 \text{ k}\Omega, R_{RX} = 60 \text{ k}\Omega$$

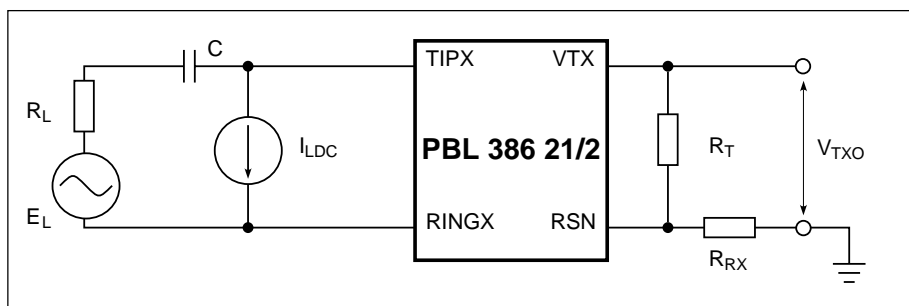


Figure 5. Overload level,  $V_{TXO}$ , four-wire transmit port

$$\frac{1}{\omega C} \ll R_L, R_L = 600 \Omega$$

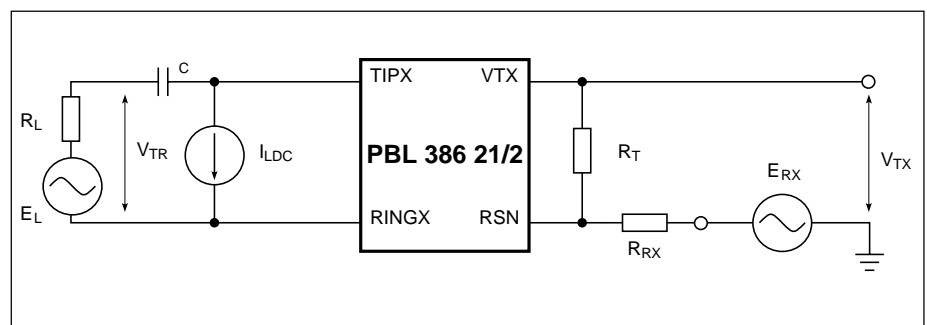
$$R_T = 120 \text{ k}\Omega, R_{RX} = 60 \text{ k}\Omega$$

Parameter	Ref fig	Conditions	Min	Typ	Max	Unit
Four-wire to two-wire, $g_{4-2}$	6	relative to 0 dBm, 1.0 kHz. $E_L=0$ V				
		0.3 kHz < f < 3.4 kHz	-0.2		0.1	dB
		f = 8 kHz, 12 kHz, 16 kHz	-1.0 -2.0		0 0	dB dB
Four-wire to four-wire, $g_{4-4}$	6	relative to 0 dBm, 1.0 kHz, $E_L=0$ V 0.3 kHz < f < 3.4 kHz	-0.2		0.1	dB
<b>Insertion loss</b>						
Two-wire to four-wire, $G_{2-4}$	6	0 dBm, 1.0 kHz, Note 5				
		$G_{2-4} = 20 \cdot \text{Log} \left  \frac{V_{TX}}{V_{TR}} \right $ ; $E_{RX} = 0$	-0.2		0.2	dB
		PTG = AGND	-6.22	-6.02	-5.82	dB
Four-wire to two-wire, $G_{4-2}$	6	0 dBm, 1.0 kHz, Note 6				
		$G_{4-2} = 20 \cdot \text{Log} \left  \frac{V_{TR}}{E_{RX}} \right $ ; $E_L = 0$	-0.2		0.2	dB
<b>Gain tracking</b>						
Two-wire to four-wire	6	Ref. -10 dBm, 1.0 kHz, Note 7				
		-40 dBm to +0 dBm	-0.1		0.1	dB
		-55 dBm to -40 dBm	-0.2		0.2	dB
Four-wire to two-wire	6	Ref. -10 dBm, 1.0 kHz,				
		-40 dBm to +0 dBm	-0.1		0.1	dB
		-55 dBm to -40 dBm	-0.2		0.2	dB
<b>Noise</b>						
Idle channel noise at two-wire (TIPX-RINGX) or four-wire (VTX) output		C-message weighting			12	dBrnC
		Psophometrical weighting Note 8			-78	dBmp
<b>Harmonic distortion</b>						
Two-wire to four-wire	6	0 dBm		-67	-50	dB
Four-wire to two-wire		0.3 kHz < f < 3.4 kHz		-67	-50	dB
<b>Battery feed characteristics</b>						
Constant loop current, $I_{LProg}$	12	$I_{LProg} = \frac{1\ 000}{R_{LC}} - 4.0$ (mA)	0.92 $I_{LProg}$	$I_{LProg}$	1.08 $I_{LProg}$	mA
		$I_{LProg} @ 30$ mA	0.95 $I_{LProg}$	$I_{LProg}$	1.05 $I_{LProg}$	mA
		$I_{LProg} @ 18$ mA	0.94 $I_{LProg}$	$I_{LProg}$	1.06 $I_{LProg}$	mA
		$R_{LC}$ in k $\Omega$				
Open circuit state loop current, $I_{LOC}$		$R_L = 0\Omega$	-100	0	100	$\mu$ A

Figure 6.  
Frequency response, insertion loss,  
gain tracking.

$$\frac{1}{\omega C} \ll R_L, R_L = 600 \Omega$$

$$R_T = 120 \text{ k}\Omega, R_{RX} = 60 \text{ k}\Omega$$



Parameter	Ref fig	Conditions	Min	Typ	Max	Unit
<b>Loop current detector</b>						
Programmable threshold, $I_{LTh}$		$I_{LTh} = \frac{500}{R_{LD}}$ $R_{LD}$ in $k\Omega$ , $I_{LTh} \geq 7$ mA	$0.85 \cdot I_{LTh}$	$I_{LTh}$	$1.15 \cdot I_{LTh}$	mA
<b>Ground key detector</b>						
Ground key detector threshold ( $I_{TIPX}$ and $I_{RINGX}$ difference to trigger ground key det.)			10	16	22	mA
<b>Ring trip comparator</b>						
Offset voltage, $\Delta V_{DTDR}$		Source resistance, $R_S = 0 \Omega$	-20	0	20	mV
Input bias current, $I_B$		$I_B = (I_{DT} + I_{DR})/2$	-200	-20	200	nA
Input common mode range, $V_{DT}, V_{DR}$			$V_{Bat}+1$		-1	V
<b>Ring relay driver</b>						
Saturation voltage, $V_{OL}$		$I_{OL} = 50$ mA		0.2	0.5	V
Off state leakage current, $I_{Lk}$		$V_{OH} = 12$ V			10	$\mu$ A
<b>Digital inputs (C1, C2, C3)</b>						
Input low voltage, $V_{IL}$			0		0.5	V
Input high voltage, $V_{IH}$			2.5		$V_{CC}$	V
Input low current, $I_{IL}$		$V_{IL} = 0.5$			-50	$\mu$ A
Input high current, $I_{IH}$		$V_{IH} = 2.5$ V			50	$\mu$ A
<b>Detector output (DET)</b>						
Output low voltage		$I_{OL} = 0.5$ mA			0.7	V
Internal pull-up resistor				15		$k\Omega$
<b>Power dissipation (<math>V_{Bat} = -48V</math>, <math>V_{Bat2} = -17V</math>)</b>						
$P_1$		Open circuit state, C1, C2, C3 = 0, 0, 0		10	15	mW
$P_2$		Active state, C1, C2, C3 = 0, 1, 0 Longitudinal current = 0 mA, $I_L = 0$ mA (on-hook)		60	80	mW
$P_3$		$R_L = 300 \Omega$ (off-hook)		290		mW
$P_4$		$R_L = 500 \Omega$ (off-hook)		145		mW
<b>Power supply currents (<math>V_{Bat} = -48V</math>)</b>						
$V_{CC}$ current, $I_{CC}$		Open circuit state		1.2	2.0	mA
$V_{Bat}$ current, $I_{Bat}$			-0.1	-0.05		mA
$V_{CC}$ current, $I_{CC}$		Active state		2.8	4.0	mA
$V_{Bat}$ current, $I_{Bat}$		On-hook, Long Current = 0 mA	-1.5	-1.0		mA
<b>Power supply rejection ratios</b>						
$V_{CC}$ to 2- or 4-wire port		Active State	30	42		dB
$V_{Bat}$ to 2- or 4-wire port		$f = 1$ kHz, $V_n = 100$ mV	36	45		dB
$V_{Bat2}$ to 2- or 4-wire port			40	60		dB
<b>Temperature guard</b>						
Junction threshold temperature, $T_{JG}$				145		$^{\circ}$ C
<b>Thermal resistance</b>						
28-pin PLCC, $\theta_{JP28plcc}$				39		$^{\circ}$ C/W
24-pin SOIC, $\theta_{JP24soic}$				43		$^{\circ}$ C/W
24-pin SSOP, $\theta_{JP24ssop}$				55		$^{\circ}$ C/W

**Notes**

1. The overload level can be adjusted with the resistor  $R_{OV}$  for higher levels e.g. min  $3.1 V_{Peak}$  and is specified at the two-wire port with the signal source at the four-wire receive port.
2. The two-wire impedance is programmable by selection of external component values according to:
 
$$Z_{TRX} = Z_T / |G_{2-4S} \alpha_{RSN}|$$
 where:
  - $Z_{TRX}$  = impedance between the TIPX and RINGX terminals
  - $Z_T$  = programming network between the VTX and RSN terminals
  - $G_{2-4S}$  = transmit gain, nominally = 1 (or 0.5 see pin PTG)
  - $\alpha_{RSN}$  = receive current gain, nominally = 200 (current defined as positive flowing into the receive summing node, RSN, and when flowing from ring to tip).
3. Higher return loss values can be achieved by adding a reactive component to  $R_T$ , the two-wire terminating impedance programming resistance, e.g. by dividing  $R_T$  into two equal halves and connecting a capacitor from the common point to ground.
4. The overload level can be adjusted with the resistor  $R_{OV}$  for higher levels e.g. min  $3.1 V_{Peak}$  and is specified at the four-wire transmit port, VTX, with the signal source at the two-wire port. Note that the gain from the two-wire port to the four-wire transmit port is  $G_{2-4S} = 1$  (or 0.5 see pin PTG)
5. Pin PTG = Open sets transmit gain to nom. 0.0dB  
Pin PTG = AGND sets transmit gain to nom. -6.02 dB  
Secondary protection resistors  $R_F$  and resistors  $R_P$  impact the insertion loss as explained in the text, section Transmission. The specified insertion loss is for  $R_F = R_P = 0$ .
6. The specified insertion loss tolerance does not include errors caused by external components.
7. The level is specified at the two-wire port.
8. The two-wire idle noise is specified with the port terminated in  $600 \Omega (R_L)$  and with the four-wire receive port grounded ( $E_{RX} = 0$ ; see figure 6).  
The four-wire idle noise at VTX is specified with the two-wire port terminated in  $600 \Omega (R_L)$ . The noise specification is referenced to a  $600 \Omega$  programmed two-wire impedance level at VTX. The four-wire receive port is grounded ( $E_{RX} = 0$ ).

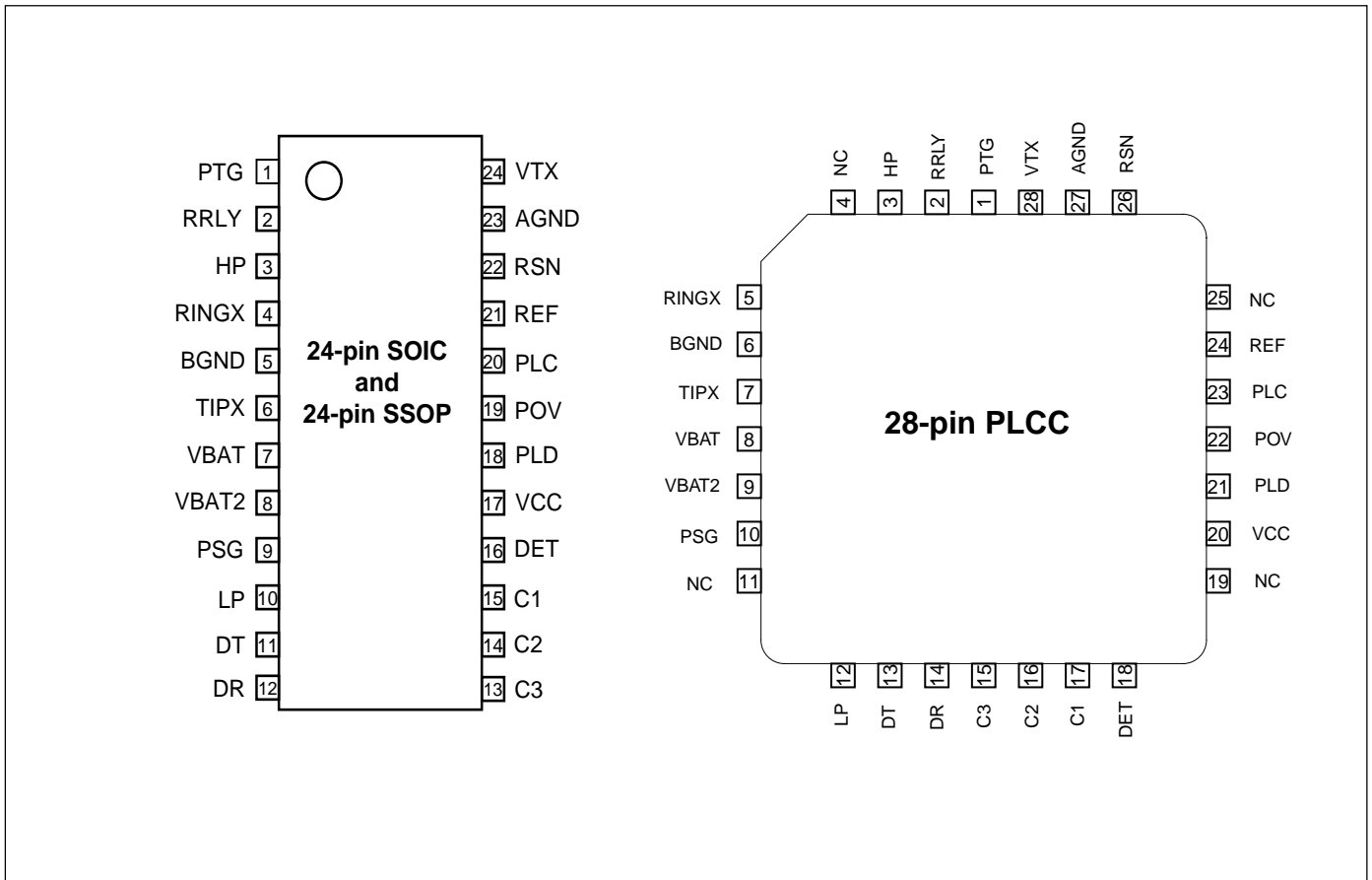


Figure 7. Pin configuration, 24-pin SSOP, 24-pin SOIC and 28 pin PLCC package, top view.

### Pin Description

Refer to figure 7.

PLCC	Symbol	Description
1	PTG	<b>Prog. Transmit Gain.</b> Left open transmit gain = 0.0 dB, connected to AGND transmit gain = -6.02 dB.
2	RRLY	<b>Ring Relay</b> driver output. The relay coil may be connected to maximum +14V.
3	HP	Connection for <b>High Pass</b> filter capacitor, $C_{HP}$ . Other end of $C_{HP}$ connects to TIPX.
4	NC	<b>No internal Connection.</b>
5	RINGX	The TIPX and RINGX pins connect to the tip and ring leads of the two-wire interface via overvoltage protection components and ring relay (and optional test relay).
6	BGND	<b>Battery Ground</b> , should be tied together with AGND.
7	TIPX	The TIPX and RINGX pins connect to the tip and ring leads of the two-wire interface via overvoltage protection components and ring relay (and optional test relay).
8	VBAT	<b>Battery supply Voltage.</b> Negative with respect to GND.
9	VBAT2	An optional second (2) <b>Battery Voltage</b> connects to this pin via an external diode.
10	PSG	<b>Programmable Saturation Guard.</b> The resistive part of the DC feed characteristic is not used for PBL 386 21/2, RSG = 0 $\Omega$ .
11	NC	<b>No internal Connection.</b>
12	LP	Connection for <b>Low Pass</b> filter capacitor, $C_{LP}$ . Other end of $C_{LP}$ connects to VBAT.
13	DT	Input to the ring trip comparator. With DR more positive than DT the detector output, DET, is at logic level low, indicating off-hook condition. The external ring trip network connects to this input.
14	DR	Input to the ring trip comparator. With DR more positive than DT the detector output, DET, is at logic level low, indicating off-hook condition. The external ring trip network connects to this input.



15	C3	}	C1, C2 and C3 are digital inputs (internal pull-up) controlling the SLIC operating states. Refer to section "Operating states" for details.
16	C2		
17	C1		
18	DET	<b>D</b> etector output. Active low when indicating loop detection and ring trip, active high when indicating ground key detection.	
19	NC	<b>N</b> o internal <b>C</b> onnection.	
20	VCC	+5 V power supply.	
21	PLD	<b>P</b> rogrammable <b>L</b> oop <b>D</b> etector threshold. The loop detection threshold is programmed by a resistor connected from this pin to AGND.	
22	POV	<b>P</b> rogrammable <b>O</b> verhead <b>V</b> oltage. If pin is left open: The overhead voltage is internally set to min 1.0 V in off-and on-hook. If a resistor is connected between this pin and AGND: the overhead voltage can be set to higher values.	
23	PLC	<b>P</b> rog. <b>L</b> ine <b>C</b> urrent, the constant current part of the DC feed characteristic is programmed by a resistor connected from this pin to AGND.	
24	REF	A <b>R</b> eference, 49.9 kΩ, resistor should be connected from this pin to AGND.	
25	NC	<b>N</b> o internal <b>C</b> onnection.	
26	RSN	<b>R</b> ecieve <b>S</b> umming <b>N</b> ode. 200 times the AC-current flowing into this pin equals the metallic (transversal) AC-current flowing from RINGX to TIPX. Programming networks for two-wire impedance and receive gain connect to the receive summing node. A resistor should be connected from this pin to AGND.	
27	AGND	Analog Ground, should be tied together with BGND.	
28	VTX	Transmit vf output. The AC voltage difference between TIPX and RINGX, the AC metallic voltage, is reproduced as an unbalanced GND referenced signal at VTX with a gain of one (or one half, see pin PTG). The two-wire impedance programming network connects between VTX and RSN.	

**SLIC Operating States**

State	C3	C2	C1	SLIC operating state	Active detector
0	0	0	0	Open circuit	-
1	0	0	1	Ringing state	Ring trip detector (active low)
2	0	1	0	Active state	Loop detector (active low)
3	0	1	1	Not applicable	-
4	1	0	0	Not applicable	-
5	1	0	1	Active state	Ground key detector (active high)
6	1	1	0	Active reverse	Loop detector (active low)
7	1	1	1	Active reverse	Ground key detector (active high)

Table 1. SLIC operating states.

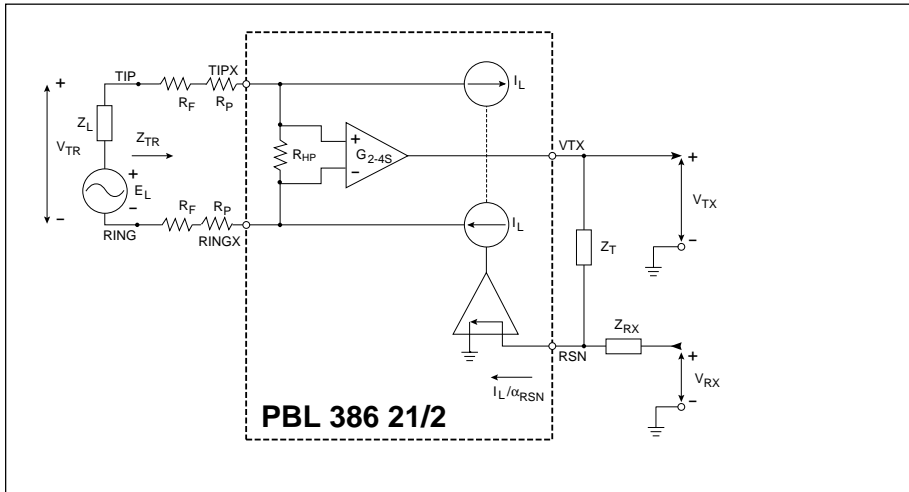


Figure 8. Simplified ac transmission circuit.

## Functional Description and Applications Information

### Transmission

#### General

A simplified ac model of the transmission circuits is shown in figure 8. Circuit analysis yields:

$$V_{TR} = \frac{V_{TX}}{G_{2-4S}} + I_L \cdot (2R_F + 2R_P) \quad (1)$$

$$\frac{V_{TX}}{Z_T} + \frac{V_{RX}}{Z_{RX}} = \frac{I_L}{\alpha_{RSN}} \quad (2)$$

$$V_{TR} = E_L - I_L \cdot Z_L \quad (3)$$

where:

- $V_{TX}$  is a ground referenced version of the ac metallic voltage between the TIPX and RINGX terminals.
- $G_{2-4S}$  is the programmable SLIC two-wire to four-wire gain (transmit direction). See note below.
- $V_{TR}$  is the ac metallic voltage between tip and ring.
- $E_L$  is the line open circuit ac metallic voltage.
- $I_L$  is the ac metallic current.
- $R_F$  is a fuse resistor.
- $R_P$  is part of the SLIC protection.
- $Z_L$  is the line impedance.
- $Z_T$  determines the SLIC TIPX to RINGX impedance at voice frequencies.
- $Z_{RX}$  controls four- to two-wire gain.
- $V_{RX}$  is the analog ground referenced receive signal.

$\alpha_{RSN}$  is the receive summing node current to metallic loop current gain = 200.

Note that the SLICs two-wire to four-wire gain,  $G_{2-4S}$ , is user programmable between two fix values. Refer to the datasheets for values on  $G_{2-4S}$ .

#### Two-Wire Impedance

To calculate  $Z_{TR}$ , the impedance presented to the two-wire line by the SLIC including the fuse and protection resistors  $R_F$  and  $R_P$  let:

$$V_{RX} = 0.$$

From (1) and (2):

$$Z_{TR} = \frac{Z_T}{\alpha_{RSN} \cdot G_{2-4S}} + 2R_F + 2R_P$$

Thus with  $Z_{TR}$ ,  $\alpha_{RSN}$ ,  $G_{2-4S}$ ,  $R_P$  and  $R_F$  known:

$$Z_T = \alpha_{RSN} \cdot G_{2-4S} \cdot (Z_{TR} - 2R_F - 2R_P)$$

#### Two-Wire to Four-Wire Gain

From (1) and (2) with  $V_{RX} = 0$ :

$$G_{2-4} = \frac{V_{TX}}{V_{TR}} = \frac{Z_T / \alpha_{RSN}}{\frac{Z_T}{\alpha_{RSN}} + 2R_F + 2R_P}$$

#### Four-Wire to Two-Wire Gain

From (1), (2) and (3) with  $E_L = 0$ :

$$G_{4-2} = \frac{V_{TR}}{V_{RX}} = -\frac{Z_T}{Z_{RX}} \cdot \frac{Z_L}{\frac{Z_T}{\alpha_{RSN}} + G_{2-4S} \cdot (Z_L + 2R_F + 2R_P)}$$

For applications where  $Z_T / (\alpha_{RSN} \cdot G_{2-4S}) + 2R_F + 2R_P$  is chosen to be equal to  $Z_L$  the expression for  $G_{4-2}$  simplifies to:

$$G_{4-2} = -\frac{Z_T}{Z_{RX}} \cdot \frac{1}{2G_{2-4S}}$$

#### Four-Wire to Four-Wire Gain

From (1), (2) and (3) with  $E_L = 0$ :

$$G_{4-4} = \frac{V_{TX}}{V_{RX}} = -\frac{Z_T}{Z_{RX}} \cdot \frac{G_{2-4S} \cdot (Z_L + 2R_F + 2R_P)}{\frac{Z_T}{\alpha_{RSN}} + G_{2-4S} \cdot (Z_L + 2R_F + 2R_P)}$$

#### Hybrid Function

The hybrid function can easily be implemented utilizing the uncommitted amplifier in conventional CODEC/filter combinations. Please, refer to figure 9. Via impedance  $Z_B$  a current proportional to  $V_{RX}$  is injected into the summing node of the combination CODEC/filter amplifier. As can be seen from the expression for the four-wire to four-wire gain a voltage proportional to  $V_{RX}$  is returned to  $V_{TX}$ . This voltage is converted by  $R_{TX}$  to a current flowing into the same summing node. These currents can be made to cancel by letting:

$$\frac{V_{TX}}{R_{TX}} + \frac{V_{RX}}{Z_B} = 0 (E_L = 0)$$

The four-wire to four-wire gain,  $G_{4-4}$ , includes the required phase shift and thus the balance network  $Z_B$  can be calculated from:

$$Z_B = -R_{TX} \cdot \frac{V_{RX}}{V_{TX}} = R_{TX} \cdot \frac{Z_{RX}}{Z_T} \cdot \frac{\alpha_{RSN}}{G_{2-4S} \cdot (Z_L + 2R_F + 2R_P)}$$

When choosing  $R_{TX}$ , make sure the output load of the VTX terminal is >20 kΩ.

If calculation of the  $Z_B$  formula above yields a balance network containing an inductor, an alternate method is recommended. Contact Ericsson Microelectronics for assistance.

The PBL 386 21/2 SLIC may also be used together with programmable CODEC/filters. The programmable CODEC/filter allows for system controller adjustment of

hybrid balance to accommodate different line impedances without change of hardware. In addition, the transmit and receive gain may be adjusted. Please, refer to the programmable CODEC/filter data sheets for design information.

**Longitudinal Impedance**

A feed back loop counteracts longitudinal voltages at the two-wire port by injecting longitudinal currents in opposing phase.

Thus longitudinal disturbances will appear as longitudinal currents and the TIPX and RINGX terminals will experience very small longitudinal voltage excursions, leaving metallic voltages well within the SLIC common mode range.

The SLIC longitudinal impedance per wire,  $Z_{LoT}$  and  $Z_{LoR}$ , appears as typically 20Ω to longitudinal disturbances. It should be noted that longitudinal currents may exceed the dc loop current without disturbing the vf transmission.

**Capacitors  $C_{TC}$  and  $C_{RC}$**

The capacitors designated  $C_{TC}$  and  $C_{RC}$  in figure 11, connected between TIPX and ground as well as between RINGX and ground, can be used for RFI filtering. The recommended value for  $C_{TC}$  and  $C_{RC}$  is 2200 pF. Higher capacitance values may be used, but care must be taken to prevent degradation of either longitudinal balance or return loss.  $C_{TC}$  and  $C_{RC}$  contribute to a metallic impedance of  $1/(\pi \cdot f \cdot C_{TC}) = 1/(\pi \cdot f \cdot C_{RC})$ , a TIPX to ground impedance of  $1/(2 \cdot \pi \cdot f \cdot C_{TC})$  and a RINGX to ground impedance of  $1/(2 \cdot \pi \cdot f \cdot C_{RC})$ .

**AC - DC Separation Capacitor,  $C_{HP}$**

The high pass filter capacitor connected between terminals HP and TIPX provides the separation of the ac signal from the dc part.  $C_{HP}$  positions the low end frequency response break point of the ac loop in the SLIC. Refer to table 1 for a recommended value of  $C_{HP}$ .

Example: A  $C_{HP}$  value of 47 nF will position the low end frequency response 3dB break point of the ac loop at 5.6 Hz ( $f_{3dB}$ ) according to  $f_{3dB} = 1/(2 \cdot \pi \cdot R_{HP} \cdot C_{HP})$  where  $R_{HP} = 600$  kΩ.

**High-Pass Transmit Filter**

The capacitor  $C_{TX}$  in figure 11 connected between the VTX output and the CODEC/filter forms, together with  $R_{TX}$  and/or the input impedance of a programmable CODEC/filter, a high-pass RC filter. It is

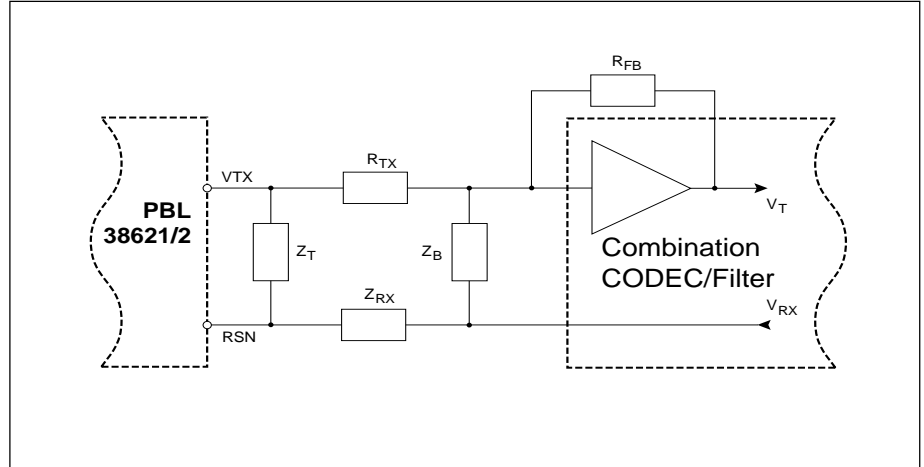


Figure 9. Hybrid function.

recommended to position the 3 dB break point of this filter between 30 and 80 Hz to get a faster response for the dc steps that may occur at DTMF signalling.

**Capacitor  $C_{LP}$**

The capacitor  $C_{LP}$ , which connects between the terminals CLP and VBAT, positions the high end frequency break point of the low pass filter in the dc loop in the SLIC.  $C_{LP}$  together with  $C_{HP}$  and  $Z_T$  (see section Two-Wire Impedance) forms the total two wire output impedance of the SLIC. The choice of these programmable components have an influence on the power supply rejection ratio (PSRR) from VBAT to the two wire side at sub-audio frequencies. At these frequencies capacitor  $C_{LP}$  also influences the transversal to longitudinal balance in the SLIC. Table 1 suggests a suitable value on  $C_{LP}$ . The typical value of the transversal to longitudinal balance (T-L bal.) at 200Hz is given in table 1 for the chosen value on  $C_{LP}$ .

$R_{Feed}$ [Ω]	$R_{SG}$ [kΩ]	$C_{LP}$ [nF]	T-L bal. @ 200Hz [dB]	$C_{HP}$ [nF]
2.25	0	150	-46	47

Table 1.  $R_{SG}$ ,  $C_{LP}$  and  $C_{HP}$  values for constant current feeding characteristics.

For values outside table 1, please contact Ericsson Microelectronics for assistance.

**Battery Feed**

The PBL 386 21/2 SLIC emulate a battery characteristic with current limitation adjustable. The open loop voltage measured between the TIPX and RINGX terminals is tracking the battery voltage  $V_{Bat}$ . The signalling headroom, or overhead voltage  $V_{TRO}$ , is programmable with a resistor  $R_{OV}$  connected between terminal POV on the SLIC and ground. Please refer to section "Programmable overhead voltage(POV)". The battery voltage overhead,  $V_{OH}$ , depends on the programmed signal overhead voltage  $V_{TRO}$ .  $V_{OH}$  defines the TIP to RING voltage at open loop conditions according to  $V_{TR}(at I_L = 0 mA) = |V_{Bat}| - V_{OH}$ . Refer to table 2 for the typical value on  $V_{OH}$ .

SLIC	$V_{OH}(typ)$ [V]
PBL 386 21/2	$2.5 + V_{TROprog}$

Table 2. Battery overhead.

The current limit (reference A - C in figure 12) is adjusted by connecting a resistor,  $R_{LC}$ , between terminal PLC and ground according to the equation:

$$R_{LC} = \frac{1000}{I_{LPprog} + 4}$$

where  $R_{LC}$  is in kΩ for  $I_{LPprog}$  in mA.

A second, lower battery voltage may be connected to the device at terminal VBAT2 to reduce short loop power dissipation.

The SLIC automatically switches between the two battery supply voltages without need for external control. The silent battery

switching occurs when the line voltage passes the value

$$|VB2| - 40 \cdot I_L - V_{TRO} = 3.6$$

For correct functionality it is important to connect the terminal VBAT2 to the second power supply via the diode  $D_{VB2}$  in figure 11. An optional diode  $D_{BB}$  connected between terminal VB and the VB2 power supply, see figure 11, will make sure that the SLIC continues to work on the second battery even if the first battery voltage disappears. If a second battery voltage is not used, VBAT2 is connected to VBAT on the SLIC and  $C_{VB2}$ ,  $D_{BB}$  and  $D_{VB2}$  are removed.

### CODEC Receive Interface

The PBL 386 21/2 SLIC have got a completely new receive interface at the four wire side which makes it possible to reduce the number of capacitors in the applications and to fit both single and dual battery feed CODECs. The RSN terminal, connecting to the CODEC receive output via the resistor  $R_{RX}$ , is dc biased with +1.25V. This makes it possible to compensate for currents floating due to dc voltage differences between RSN and the CODEC output without using any capacitors. This is done by connecting a resistor  $R_R$  between the RSN terminal and ground. With current directions defined as in figure 13, current summation gives:

$$-I_{RSN} = I_{RT} + I_{RRX} + I_{RR} =$$

$$\frac{1,25}{R_T} + \frac{1,25 - V_{CODEC}}{R_{RX}} + \frac{1,25}{R_R}$$

where  $V_{CODEC}$  is the reference voltage of the CODEC at the receive output. From this equation the resistor  $R_R$  can be calculated as

$$R_R = \frac{1,25}{-I_{RSN} - \frac{1,25}{R_T} - \frac{1,25 - V_{CODEC}}{R_{RX}}}$$

For the value on  $I_{RSN}$ , see table 3. The resistor  $R_R$  has no influence on the ac transmission.

SLIC	$I_{RSN}$ [ $\mu$ A]
PBL 386 21/2	-55

Table 3. The SLIC internal bias current with the direction of the current defined as positive when floating into the terminal RSN.

### Programmable overhead voltage(POV)

With the POV function the overhead voltage can be increased. If the POV pin is left open the overhead voltage is internally set to 1.1  $V_{Peak}$ . The overhead voltage is equal in on-hook and off-hook. If a resistor  $R_{OV}$  is connected between the POV pin and AGND, the overhead voltage can be set to higher values, typical values can be seen in figure 10. The  $R_{OV}$  and corresponding  $V_{TRO}$  (signal headroom) are typical values for THD <1% and the signal frequency 1000Hz.

Observe that the 4-wire output terminal  $V_{TX}$  can not handle more than 3.2  $V_{Peak}$ . So if the gain 2-wire to 4-wire is 0dB, 3.2  $V_{Peak}$  is maximum also for the 2-wire side. Signal levels between 3.2 and 6.4  $V_{Peak}$  on the 2-wire side can be handled with the PTG shorted so that the gain  $G_{2-4S}$  become -6.02dB. Please note that the 2-wire impedance,  $R_R$  and the 4-wire to 4-wire gain has to be recalculated if the PTG is shorted.

Please note that the maximum signal current at the 2-wire side can not be greater than 9 mA.

How to use POV:

1. Decide what overhead voltage ( $V_{TRO}$ ) is needed. The POV function is only needed if the overhead voltage exceeds 1.1  $V_{Peak}$ .
2. In figure 10 the corresponding  $R_{OV}$  for the decided  $V_{TRO}$  can be found.
3. If the overhead voltage exceeds 3.2  $V_{Peak}$ , the  $G_{2-4S}$  gain has to be changed to -6.02dB by connecting the PTG pin to AGND. Please note that the 2-wire impedance,  $R_R$  and the 4-wire to 4-wire gain has to be recalculated.

### Analog Temperature Guard

The widely varying environmental conditions in which SLICs operate may lead to the chip temperature limitations being exceeded. The PBL 386 21/2 SLIC reduce the dc line current when the chip temperature reaches approximately 145°C and increases it again automatically when the temperature drops. Accordingly transmission is not lost under high ambient temperature conditions.

The detector output, DET, is forced to a logic low level when the temperature guard is active.

### Loop Monitoring Functions

The loop current, ground key and ring trip detectors report their status through a common output, DET. The detector to be connected to DET is selected via the three bit wide control interface C1, C2 and C3. Please refer to section Control Inputs for a description of the control interface.

#### Loop Current Detector

The loop current detector is indicating that the telephone is off hook and that current is flowing in the loop by putting the output DET to a logical low level when selected. The loop current threshold value,  $I_{LTh}$ , at which the loop current detector changes state is programmable by selecting the value of resistor  $R_{LD}$ .  $R_{LD}$  connects between pin PLD and ground and is calculated according to

$$R_{LD} = \frac{500}{I_{LTh}}$$

The current detector is internally filtered and is not influenced by the ac signal at the two wire side.

#### Ground Key Detector

The ground key detector is indicating when the ground key is pressed (active) by putting the output pin DET to a logical high level when selected. The ground key detector circuit senses the difference in TIPX and RINGX currents. When the current at the RINGX side exceeds the current at the TIPX side with the threshold value the detector is triggered. For threshold current values, please refer to the datasheet.

#### Ring Trip Detector

Ring trip detection is accomplished by connecting an external network to a comparator in the SLIC with inputs DT and DR. The ringing source can be balanced or unbalanced superimposed on  $V_b$  or GND. The unbalanced ringing source may be applied to either the ring lead or the tip lead with return via the other wire. A ring relay driven by the SLIC ring relay driver connects the ringing source to tip and ring.

The ring trip function is based on a polarity change at the comparator input when the line goes off-hook. In the on-hook state no dc current flows through the loop and the voltage at comparator input DT is more positive than the voltage at input DR. When the line goes off-hook, while the ring relay

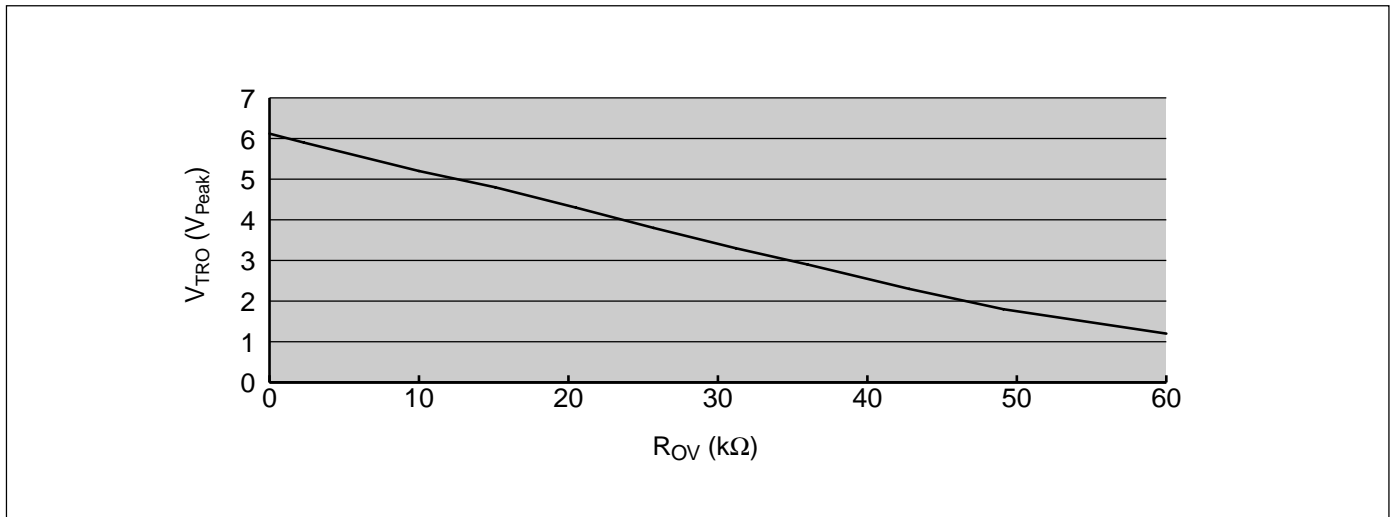


Figure 10. Programmable overhead voltage (POV).  $R_L = 600 \Omega$  or  $\infty$ .

is energized, dc current flows and the comparator input voltage reverses polarity.

Figure 11 gives an example of a ring trip detection network. This network is applicable, when the ring voltage is superimposed on  $V_B$  and is injected on the ring lead of the two-wire port. The dc voltage across sense resistor  $R_{RT}$  is monitored by the ring trip comparator input DT and DR via the network  $R_1, R_2, R_3, R_4, C_1$  and  $C_2$ . With the line on-hook (no dc current) DT is more positive than DR and the DET output will report logic level high, i.e. the detector is not tripped. When the line goes off-hook, while ringing, a dc current will flow through the loop including sense resistor  $R_{RT}$  and will cause input DT to become more negative than input DR. This changes output DET to logic level low, i.e. tripped detector condition. The system controller (or line card processor) responds by de-energizing the ring relay, i.e. ring trip.

Complete filtering of the 20 Hz ac component at terminal DT and DR is not necessary. A toggling DET output can be examined by a software routine to determine the duty cycle. When the DET output is at logic level low for more than half the time, off-hook condition is indicated.

### Relay driver

The PBL 386 21/2 SLIC incorporates a ring relay driver designed as open collector (npn) with a current sinking capability of 50 mA. The drive transistor emitter is connected to BGND. The relay driver has an internal zener diode clamp for inductive kick-back voltages. Care must be taken when using the relay driver together with relays that have high impedance.

### Control Inputs

The PBL 386 21/2 SLIC has three digital control inputs, C1, C2 and C3.

A decoder in the SLIC interprets the control input condition and sets up the commanded operating state.

C1 to C3 are internal pull-up inputs.

### Open Circuit State

In the Open Circuit State the TIPX and RINGX line drive amplifiers as well as other circuit blocks are powered down. This causes the SLIC to present a high impedance to the line. Power dissipation is at a minimum and no detectors are active.

### Ringing State

The ring relay driver and the ring trip detector are activated and the ring trip detector is indicating off hook with a logic low level at the detector output.

As the SLIC do not have any stand by state the SLIC will remain in the active normal state.

### Active States

TIPX is the terminal closest to ground and sources loop current while RINGX is the more negative terminal and sinks loop current. Vf signal transmission is normal. The loop current or the ground key detector is activated. The loop current detector is indicating off hook with a logic low level and the ground key detector is indicating active ground key with a logic high level present at the detector output.

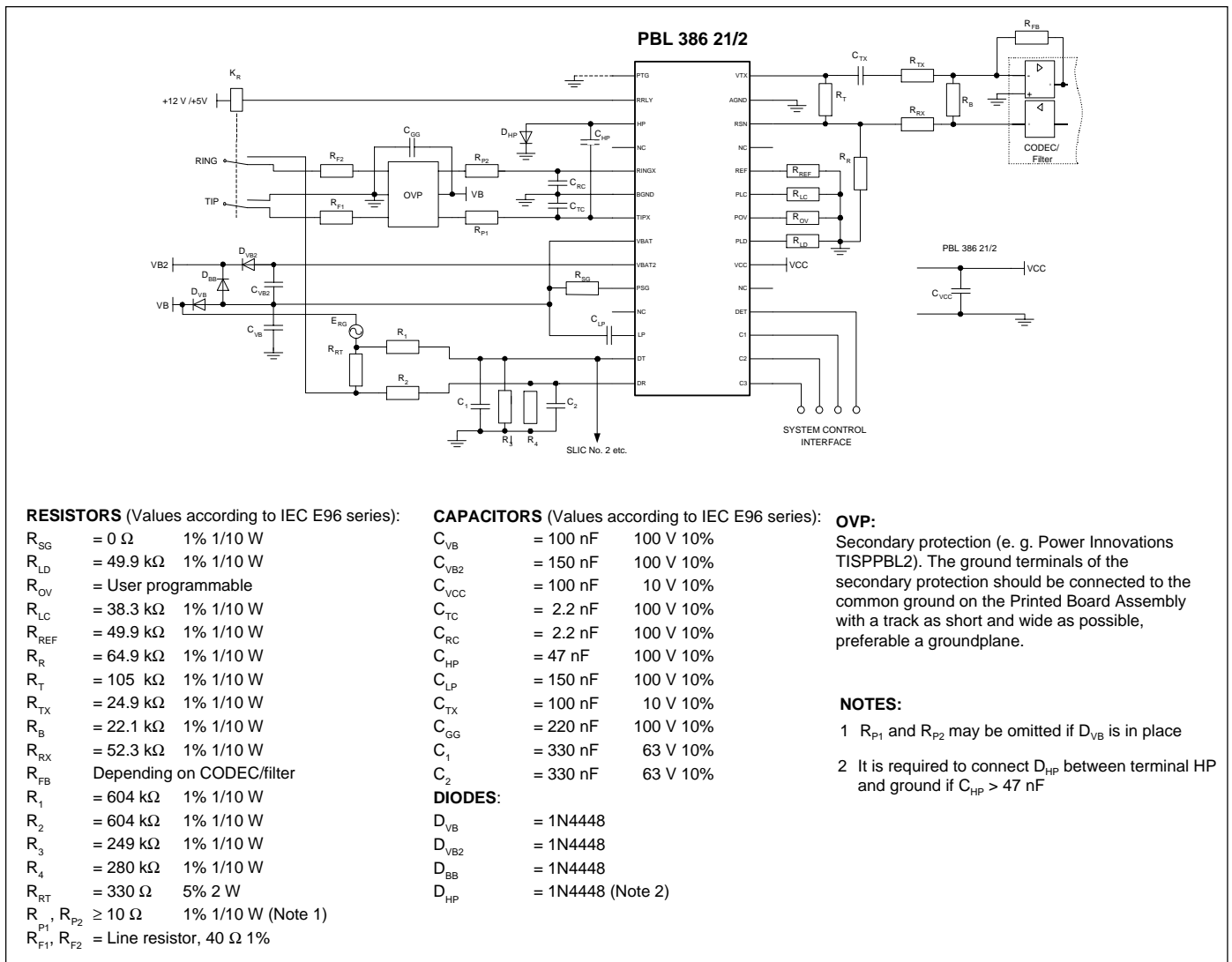


Figure 11. single-channel subscriber line interface with PBL 386 21/2 and combination CODEC/filter.

## Overvoltage Protection

The PBL 386 21/2 SLIC must be protected against overvoltages on the telephone line caused by lightning, ac power contact and induction. Refer to Maximum Ratings, TIPX and RINGX terminals, for maximum allowable continuous and transient currents that may be applied to the SLIC.

### Secondary Protection

The circuit shown in figure 11 utilizes series resistors together with a programmable overvoltage protector (e.g Power Innovations TISPPBL2), serving as a secondary protection. The TISPPBL2 is a dual forward-conducting buffered p-gate overvoltage protector. The protector gate references the protection (clamping) voltage to negative supply voltage (i.e the battery voltage,  $V_B$ ).

As the protection voltage will track the negative supply voltage the overvoltage stress on the SLIC is minimized.

Positive overvoltages are clamped to ground by a diode. Negative overvoltages are initially clamped close to the SLIC negative supply rail voltage and the protector will crowbar into a low voltage on-state condition, by firing an internal thyristor.

A gate decoupling capacitor,  $C_{GG}$ , is needed to carry enough charge to supply a high enough current to quickly turn on the thyristor in the protector.  $C_{GG}$  shall be placed close to the overvoltage protection device. Without the capacitor even the low inductance in the track to the  $V_{Bat}$  supply will limit the current and delay the activation of the thyristor clamp.

The fuse resistors  $R_F$  serve the dual purposes of being non-destructive energy dissipators, when transients are clamped and of being fuses, when the line is exposed to a power cross.

If a PTC is chosen for  $R_F$ , note that it is important to always use PTC's in series with resistors not sensitive to temperature, as the PTC will act as a capacitance for fast transients and therefore will not protect the SLIC.

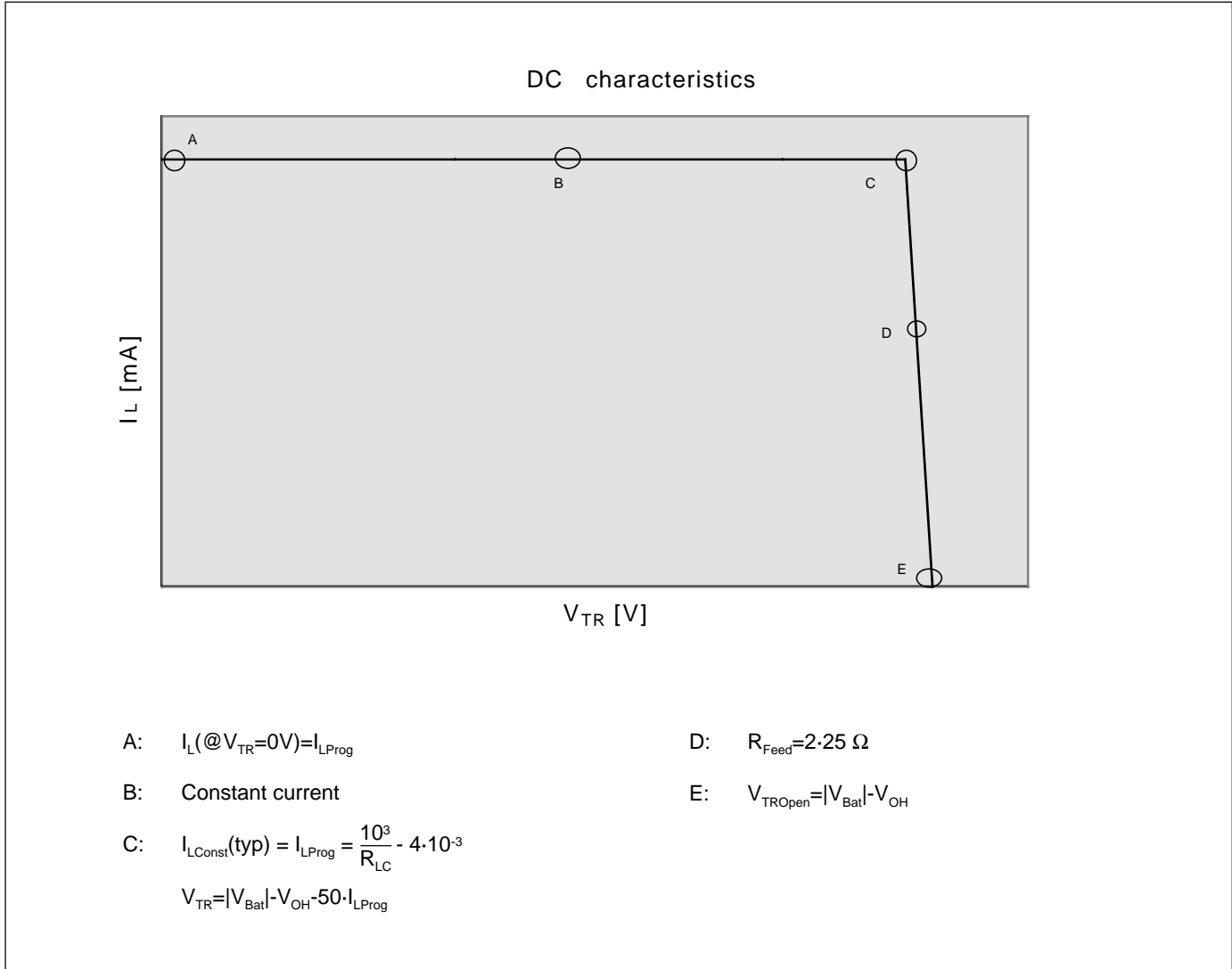


Figure 12. Battery feed characteristics (without the protection resistors on the line).

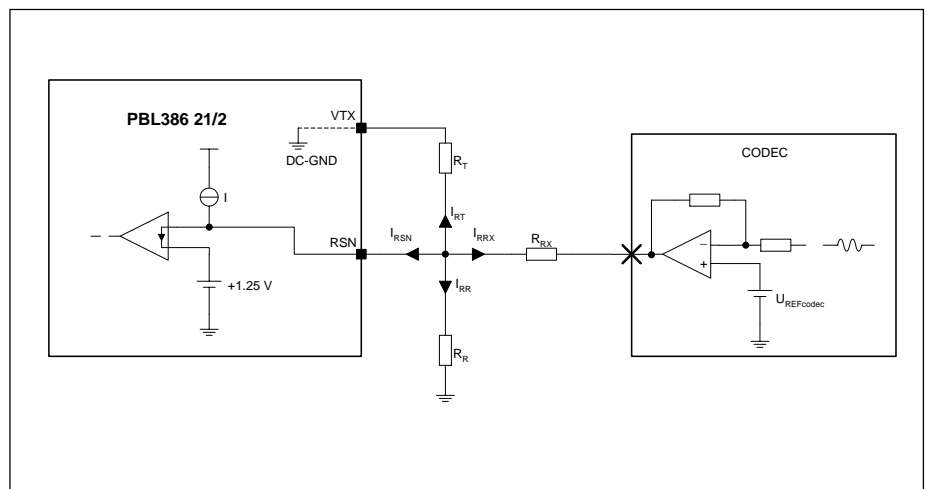


Figure 13. CODEC receive interface.

## Power-up Sequence

No special power-up sequence is necessary except that ground has to be present before all other power supply voltages.

## Printed Circuit Board Layout

Care in PCB layout is essential for proper function. The components connecting to the RSN input should be placed in close proximity to that pin, such that no interference is injected into the RSN pin. Ground plane surrounding the RSN pin is advisable.

Analog ground (AGND) should be connected to battery ground (BGND) on the PCB in one point. The capacitors for the battery should be connected with short wide leads of the same length.

## Ordering Information

Package	Temp. Range	Part No.
24 pin SSOP Tape & Reel	-40° - +85° C	PBL 386 21/2SHT
24 pin SOIC Tube	-40° - +85° C	PBL 386 21/2SOS
24 pin SOIC Tape & Reel	-40° - +85° C	PBL 386 21/2SOT
28 pin PLCC Tube	-40° - +85° C	PBL 386 21/2QNS
28 pin PLCC Tape & Reel	-40° - +85° C	PBL 386 21/2QNT

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1522-PBL 386 21/2 Uen Rev. A

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